

SM12T 6.0 x 3.5 x 1.0 mm Ceramic Package

Features

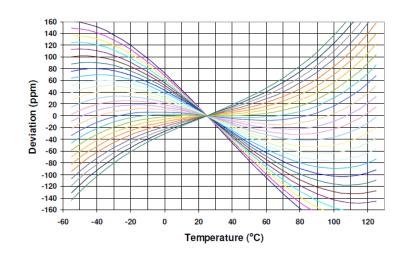
- Miniature low profile surface mount crystal.
- Package is ideal for automated surface mount assembly and reflow practices.
- Tape and Reel Packaging.
- AT Cut Crystal
- 10 MHz to 150 MHz

Applications

Bluetooth WLAN IoT

Electrical Characteristics					
Parameter	Min	Тур	Max	Unit	Condition (Consult factory for other options)
Frequency Range	10.0	1	150.0	MHz	
Calibration Frequency Tolerance	±10	-	±50	ppm	at +25°C ± 3°C, see part number guide below for available options
Frequency Stability	±5	-	±100	ppm	see part number guide below for available options
Operating Temperature Range	-40	-	+125	°C	see part number guide below for available options
Storage Temperature Range	-55	-	+125	°C	
Equivalent Series Resistance (ESR)	-	-	60 50 100	Ω	10 MHz ≤ Freq < 16 MHz 16 MHz ≤ Freq ≤ 50 MHz 40 MHz ≤ Freq < 150 MHz (3rd Overtone)
Drive Level	-	-	100	μW	Use 10µW for testing
Shunt Capacitance (C0)	-	-	5.0	pF	Pad to Pad Capacitance
A min m at 05°C + 0°C	-	-	±3	ppm	for the first year
Aging at 25°C ± 3°C	-	-	±2	ppm	after the first year

AT Cut Crystal Frequency versus Temperature Typical Performance:





Part Nur	nbering								
Series Model	Load Capacitance (CLoad) in pF	Frequency in MHz	Frequency Calibration Tolerance	Frequency Stability	AT Cut Crystal		Temperature ange	Internal Code Or Blank	
						Lowest	Highest	Blunk	
SM12T	-8 -25.01		-20	Н	1	G G		-xx	
	Parallel Resonance from 06 to 32 pF SR = Series Resonance		(Typical Values Shown) 10 = ±10 ppm 15 = ±15 ppm 20 = ±20 ppm (Standard) 25 = ±25 ppm 50 = ±50 ppm	See Table Below	1 = Fundamental 3 = 3rd OT	C = 0°C D = -5°C E = -10°C G = -20°C J = -30°C K = -35°C L = -40°C	C = +50°C E = +60°C G = +70°C H = +75°C J = +80°C K = +85°C P = +105°C U = +125°C		

Operating Ter	mperature								
Rang	ge	В	С	D	E	F	G	Н	J
	CODE	±5	±8	±10	±15	±20	±30	±50	±100
0 to +50°C	CC	•	•	•	•	•	•	•	•
0 to +60°C	CE	•	•	•	•	•	•	•	•
0 to +70°C	CG		•	•	•	•	•	STD	•
-10 to +50°C	EC	•	•	•	•	•	•	•	•
-10 to +60°C	EE	•	•	•	•	•	•	•	•
-10 to +70°C	EH		•	•	•	•	•	•	•
-20 to +70°C	GG		•	•	•	•	•	•	•
-20 to +75°C	GH		•	•	•	•	•	•	•
-30 to +75°C	JH			•	•	•	•	•	•
-30 to +85°C	JK			•	•	•	•	•	•
-35 to +80°C	KJ				Δ	•	•	•	•
-40 to +85°C	LK				Δ	•	•	•	•
-40 to +105°C	LP					•	•	•	•
-40 to +125°C	LU						Δ	•	•

• = Available \triangle = Check with Pletronics

Product information is current as of publication date. The product conforms to specifications per the terms of the Pletronics standard warranty.

June 12, 2024 Rev. K
Production processing does not necessarily include testing of all parameters.



Device Marking

fff.fff PywwC

OR

fff.fffM PymdC fff.fff = Crystal Frequency in MHz x = Internal factory codes

P = Pletronics

YMD or YWW = Date code (Year-WeekWeek or Year-Month-Day; see chart below)

= Capacitance load

Specifications such as part number, frequency stability, supply voltage and operating temperature range, etc. are not identified from marking. External packaging labels and packing list will correctly identify the ordered Pletronics part number.

Codes for Date Code YMD (Year Month Day)

Code		4		5		6	6	7	,	8		Cod	le	Α		В	С		D	Е		F	G		Н	J		K	L		M
Year	2	2024	Ļ	202	25	20	26	202	27	202	8	Mon	th	JAN	I F	EB	MA	R	APR	MA	Y.	JUN	JUL	Α	UG	SEF	C	СТ	NO\	/ D	EC
Code	1	2	3	4	5	6	7	8	9	Α	В	С	D	Е	F	G	Н	J	K	L	М	N	Р	R	Т	U	٧	W	Х	Υ	Z
Day	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31

Codes for Load Capacitance

Cod	le	Α	В	С	D	Е	F	G	Н	J	K	L	М	N	Р	Q	R	S	Т	U	٧	W	Х	Υ
рF	: '	10	12	13	8	15	18	20	22	24	26	28	30	32	34	36	27	Series	33	50	19	16	17	14

Package Labeling

P/N Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Courier New Bar code is 39-Full ASCII

1000 MSL: 1 RoHS Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

RoHS Compliant

2nd LvL Interconnect

Category=e4

Max Safe Temp=260C for 10s 2X Max

Pletronics Inc. certifies this device is in accordance with the RoHS and REACH directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's Weight of the Device: 0.064 grams

Moisture Sensitivity Level: 1 As defined in J-STD-020D

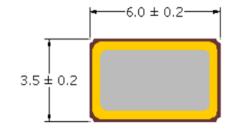
Second Level Interconnect code: e4

Reliability

Parameter	Condition
Mechanical Shock	MIL-STD-883, Method 2002, Condition B
Vibration	MIL-STD-883, Method 2007, Condition A
Solderability	IPC J-STD-002
Thermal Cycle	MIL-STD-883 Method 1010, Condition B



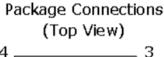
Mechanical Dimensions

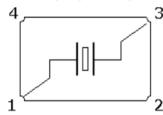




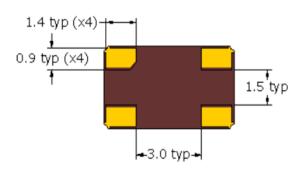


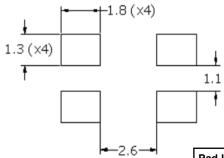






Pads 2 and 4 connected to lid (attach either to ground)





Dimensions in mm

Pad Layout

Disclaimer: Recommended layout shown. Adjust layout as needed for individual process requirements.

Contacts (pads): Gold (0.3 to 1µm) over Nickel (1.27 to 8.89 µm)

The chamfered pad may or may not be present and may be on any pad. The crystal is symmetrical, there is no Pad 1 preference. The part can be rotated 180° when being assembled on the PCB and will still perform correctly.

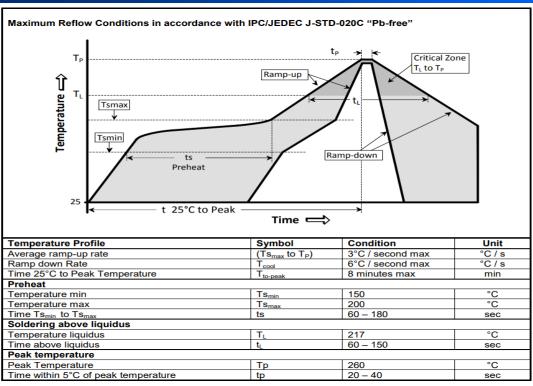
For Optimum Jitter Performance, Pletronics recommends:

- Trace lengths to the crystal should be kept as short as possible.
- The crystal connections are sensitive to noise.
- The package should be grounded for optimum performance, pad 2 or 4 connected to ground.
- These very small crystals have high ESR, the oscillator start-up and operation should take this into consideration.
- These small crystals should have their maximum drive level limited to 100 µW.

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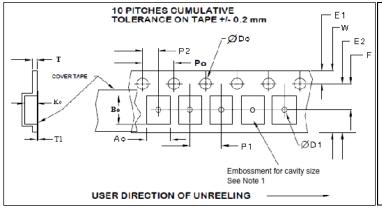
Reflow Cycle

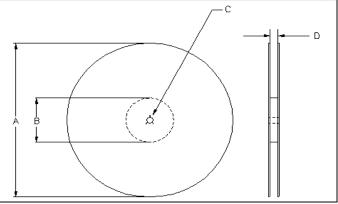


The part may be reflowed 2 times without degradation (typical for lead free processing).

Tape and Reel

Tape and Reel available for quantities of 250 to 1000 per reel, cut tape for < 1000. 16mm tape, 8mm pitch.





	Tape Variable Dimensions Table 2												
Tape Size	Tape E2 F P1 W Ao Bo Ko												
16mm	14.25	7.5 ±0.05	8.0 ± 0.1	16.3	3.95±0.1	6.5±0.1	1.35±0.1						

Dimensions in mm Drawing Not to scale Note 1: Embossed cavity to conform to EIA- 481-B

	Tape Constant Dimensions Table 1												
Tape Size	Do	D1 min	E1	Ро	P2	T max	T1 max						
16mm	1.5 +0.1 -0.0	1.5	1.75 ±0.1	4.0 ±0.1	2.0 ±0.1	0.3	0.1						

	Ree	l Dimens	y vary)	Table :	3	
		A	В		С	D
Reel Size	Inch- es	mm	Inches	mm	mm	mm
_	7.0	400	0.50	00	13.0	Tape size +0.4
7	7.0	180	2.50	60	+0.5 -0.2	+2.0 -0.0

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